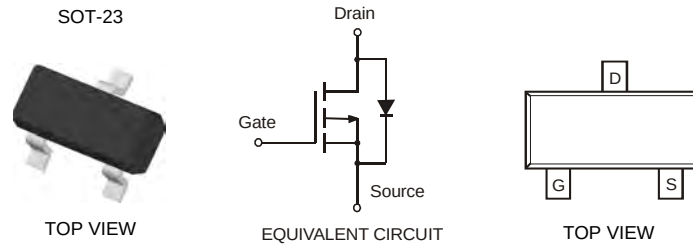


Features

- Low On-Resistance:
 $R_{DS(ON)} < 122\text{m}\Omega$ @ $V_{GS} = -10\text{V}$, $I_D = -2.7\text{A}$
 $R_{DS(ON)} < 190\text{m}\Omega$ @ $V_{GS} = -4.5\text{V}$, $I_D = -2.0\text{A}$
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 2, 4 and 6)**
- Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish — Matte Tin annealed over Copper leadframe.
Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)



Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V_{DSS}	-30	V
Gate-Source Voltage			V_{GSS}	± 20	V
Drain Current (Note 1) $V_{GS} = -10\text{V}$	Steady State	$T_A = 25^\circ\text{C}$ $T_A = 70^\circ\text{C}$	I_D	-2.7 -2	A
Pulsed Drain Current (Note 3)			I_{DM}	-8	A

Thermal Characteristics

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 1)	P_D	1.08	W
Thermal Resistance, Junction to Ambient @ $T_A = 25^\circ\text{C}$ (Note 1)	$R_{\theta JA}$	115	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)						
Drain-Source Breakdown Voltage	BV_{DSS}	-30	—	—	V	$V_{GS} = 0\text{V}$, $I_D = -250\mu\text{A}$
Zero Gate Voltage Drain Current	I_{DSS}	—	—	-800	nA	$V_{DS} = -30\text{V}$, $V_{GS} = 0\text{V}$
Gate-Source Leakage	I_{GSS}	—	—	± 80 ± 800	nA	$V_{GS} = \pm 12\text{V}$, $V_{DS} = 0\text{V}$ $V_{GS} = \pm 15\text{V}$, $V_{DS} = 0\text{V}$
ON CHARACTERISTICS (Note 5)						
Gate Threshold Voltage	$V_{GS(th)}$	-1.3	-1.8	-2.1	V	$V_{DS} = V_{GS}$, $I_D = -250\mu\text{A}$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	—	97 165	122 190	m Ω	$V_{GS} = -10\text{V}$, $I_D = -2.7\text{A}$ $V_{GS} = -4.5\text{V}$, $I_D = -2.0\text{A}$
Forward Transfer Admittance	$ Y_{fs} $	—	3.6	—	S	$V_{DS} = -5\text{V}$, $I_D = -2.7\text{A}$
Diode Forward Voltage (Note 5)	V_{SD}	—	—	-1.26	V	$V_{GS} = 0\text{V}$, $I_S = -2.7\text{A}$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{iss}	—	227	—	pF	$V_{DS} = -10\text{V}$, $V_{GS} = 0\text{V}$ $f = 1.0\text{MHz}$
Output Capacitance	C_{oss}	—	64	—	pF	
Reverse Transfer Capacitance	C_{rss}	—	36	—	pF	

- Notes:
- Device mounted on FR-4 PCB. $t \leq 5$ sec.
 - No purposefully added lead. Halogen and Antimony Free.
 - Pulse width $\leq 10\mu\text{s}$, Duty Cycle $\leq 1\%$.
 - Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 - Short duration pulse test used to minimize self-heating effect.
 - Product manufactured with Green Molding Compound and does not contain Halogens or Sb_2O_3 Fire Retardants.

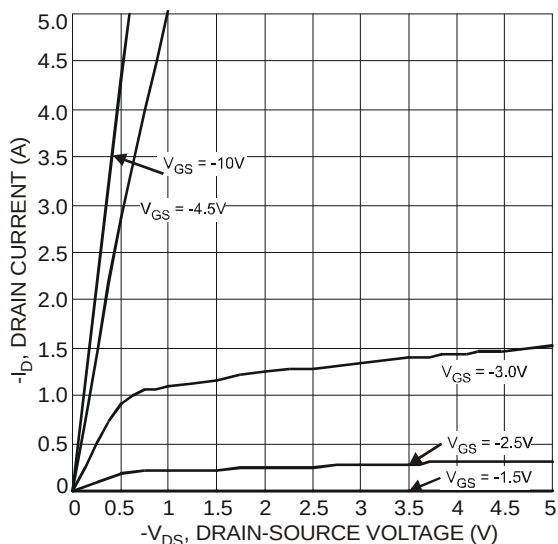


Fig. 1 Typical Output Characteristics

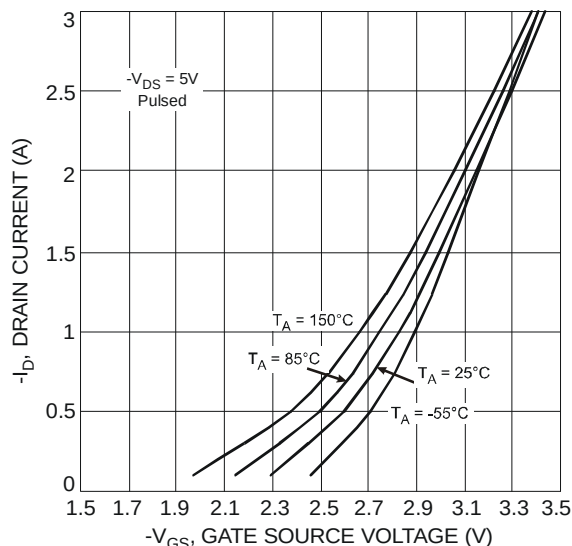


Fig. 2 Typical Transfer Characteristics

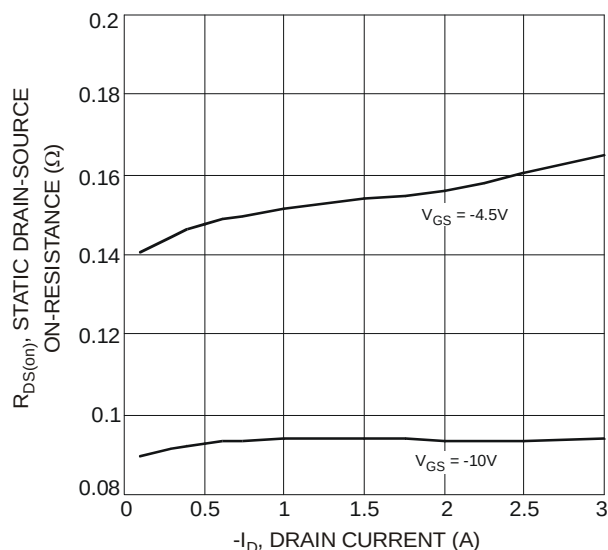


Fig. 3 On-Resistance vs. Drain Current and Gate Voltage

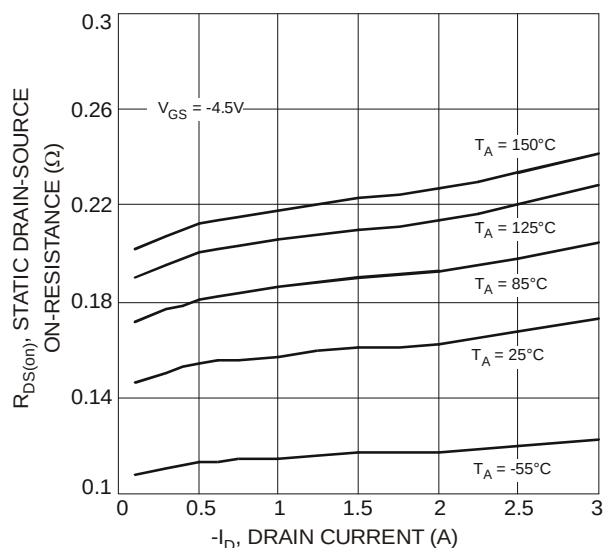


Fig. 4 On-Resistance vs. Drain Current and Gate Voltage

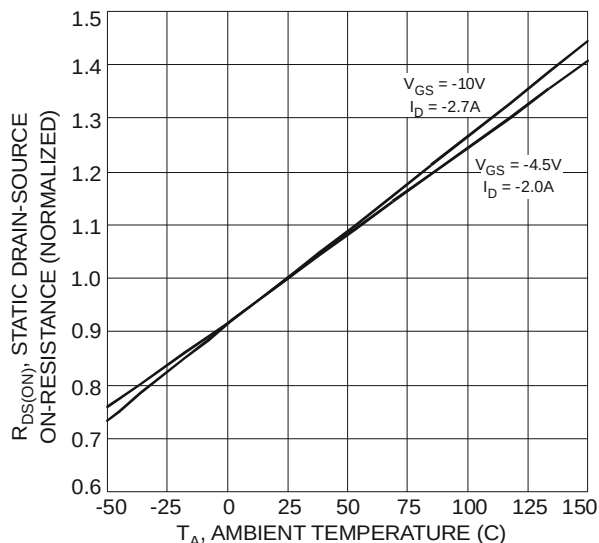


Fig. 5 Normalized Static Drain-Source On-Resistance vs. Ambient Temperature

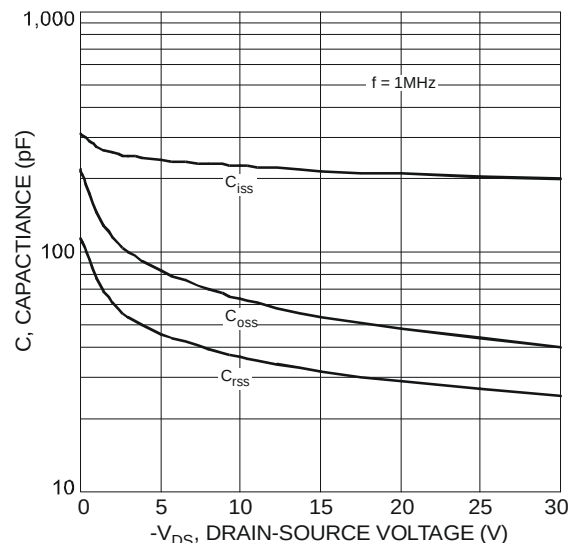
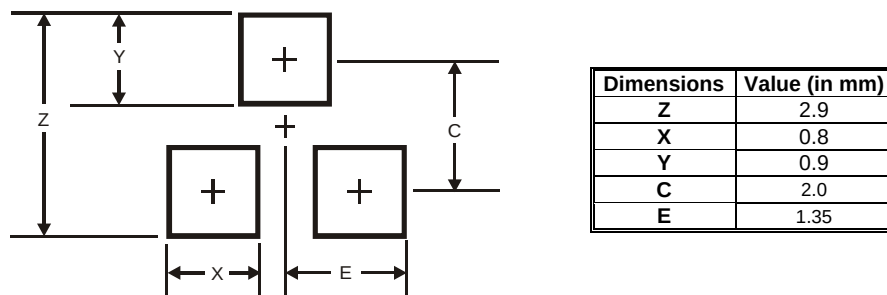


Fig. 6 Typical Capacitance

Suggested Pad Layout



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